

### Vishay General Semiconductor

# **High Voltage Trench MOS Barrier Schottky Rectifier**



PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	3.0 A		
$V_{RRM}$	200 V		
I <sub>FSM</sub>	90 A		
V <sub>F</sub> at I <sub>F</sub> = 3.0 A	0.63 V		
T <sub>J</sub> max.	150 °C		
Package	DO-201AD		
Diode variation	Single		

#### **FEATURES**

- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses



FREE

- High efficiency operation
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### TYPICAL APPLICATIONS

For use in high frequency rectifier of switching mode power supplies, freewheeling diodes, DC/DC converters or polarity protection application.

### **MECHANICAL DATA**

Case: DO-201AD

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test **Polarity:** Color band denotes the cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	VSB3200	UNIT	
Max. repetitive peak reverse voltage	$V_{RRM}$	200	V	
Max. average forward rectified current (fig. 1)	I <sub>F(AV)</sub> (1)	3.0	А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	90	А	
Voltage rate of change (rated V <sub>R</sub> )	dV/dt	10 000	V/µs	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	- 40 to + 150	°C	

#### Note

<sup>(1)</sup> Units mounted on PCB with 2 mm x 2 mm copper pad areas 0.375" (9.5 mm) lead length, free air



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Breakdown voltage	$I_R = 1.0 \text{ mA}$	T <sub>A</sub> = 25 °C	$V_{BR}$	200 (minimum)	-	
Instantaneous forward voltage (1)	I <sub>F</sub> = 3.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub>	0.86	1.20	V
		T <sub>A</sub> = 125 °C		0.63	0.71	
Reverse current per diode (2)	V <sub>R</sub> = 200 V	T <sub>A</sub> = 25 °C	I <sub>R</sub>	1.6	60	μΑ
		T <sub>A</sub> = 125 °C		1.2	9	mA
Typical juntion capacitance	4.0 V, 1 MHz		CJ	175	-	pF

#### **Notes**

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	VSB3200	UNIT	
Typical thermal resistance (1)	$R_{\theta JA}$	62	°C/W	
Typical thermal resistance (*)	$R_{ hetaJL}$	9	C/VV	

#### Note

(1) Units mounted on PCB with 2 mm x 2 mm copper pad areas 0.375" (9.5 mm) lead length, free air

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	WEIGHT (g) PREFERRED PACKAGE CODE		DELIVERY MODE	
VSB3200-M3/54	1.08	54	1400	13" diameter paper tape and reel	
VSB3200-M3/73	1.08	73	1000	Ammo pack packaging	

#### **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25 °C unless otherwise noted)

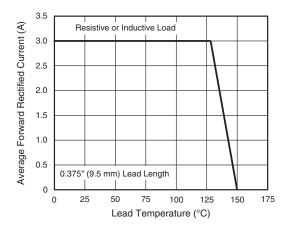


Fig. 1 - Maximum Forward Current Derating Curve

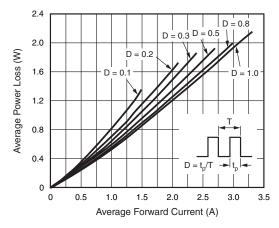


Fig. 2 - Forward Power Loss Characteristics



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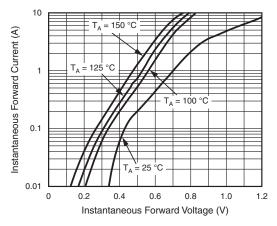
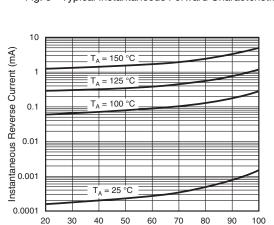


Fig. 3 - Typical Instantaneous Forward Characteristics



Percent of Rated Peak Reverse Voltage (%)
Fig. 4 - Typical Reverse Characteristics

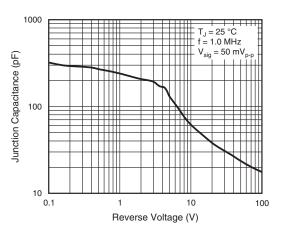


Fig. 5 - Typical Junction Capacitance

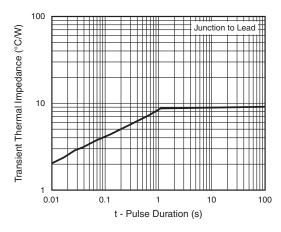
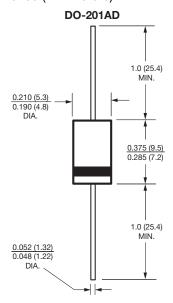


Fig. 6 - Typical Transient Thermal Impedance

### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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